

*MP2009* 

Ultra-Low-Noise Low-Dropout, 120mA Linear Regulator

DESCRIPTION

The MP2009 is an ultra low noise, low dropout linear regulator. The output voltage of MP2009 ranges from 1.5V to 4.5V in 100mV increments and 1% accuracy by operating from a +2.0V to +6.0V input. It is designed to deliver up to 120mA continuous output current. It achieves a low 120mV dropout for full load current.

The MP2009 uses an internal PMOS as the pass element, which consumes  $50\mu$ A supply current at no load condition. New innovative design techniques make MP2009 achieve ultralow output voltage noise of  $16\mu$ V<sub>RMS</sub> without a noise bypass capacitor.

The MP2009 are designed and optimized to work with low value, low cost ceramic capacitors in space-limiting and performance consideration. It requires only  $1\mu$ F (typ) of output capacitance for stability with any load. It is available in a 5-pin SC70 package.

## **FEATURES**

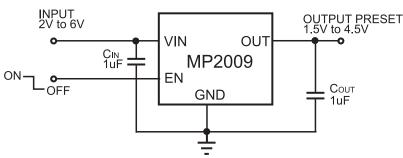
- Space-Saving SC70 Package
- 16µV<sub>RMS</sub> Output Noise (100Hz to 30kHz) No Bypass Capacitor Required
- 78dB PSRR at 1kHz
- 120mV Dropout at 120mA Load
- Stable with  $1\mu F$  Ceramic Capacitor for Any Load
- Low 50µA Ground Current
- Very Fast Line and Load Transient Response with Small Input and Output Capacitor
- Current Limit and Thermal Protection

#### **APPLICATIONS**

- Cellular and Cordless Phones
- VCOs
- PDA and Palmtop Computers
- Digital Cameras
- Base Stations
- Wireless LANs
- Bluetooth Portable Radios and Accessories
- Portable and Battery-Powered Equipment

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## **TYPICAL APPLICATION**





Part Number**	Package	VOUT(V)	Top Marking	Free Air Temperature Range (T <sub>A</sub> )
MP2009EE-1.5*		1.5		
MP2009EE-1.8	5-SC70	1.8	8B	
MP2009EE-2.5		2.5	AQ	
MP2009EE-2.6		2.6		
MP2009EE-2.7		2.7		
MP2009EE-2.8		2.8		-20°C to +85°C
MP2009EE-2.85		2.85		
MP2009EE-3		3		
MP2009EE-4.0		4.0	CG	
MP2009EE-4.5		4.5		

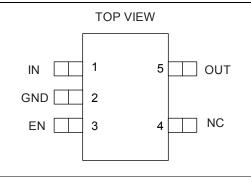
#### **ORDERING INFORMATION**

\* For Tape & Reel, add suffix –Z (eg. MP2009EE-1.5–Z).

For Lead Free, add suffix -LF (eg. MP2009EE-1.5-LF-Z)

\*\* Available options are identified by those with top marking. For other options, please contact factory to check availability.

## PACKAGE REFERENCE



### ABSOLUTE MAXIMUM RATINGS (1)

#### 

### Thermal Resistance $^{(4)}$ $\theta_{JA}$ $\theta_{JC}$

#### Notes:

- 1) Exceeding these ratings may cause permanent damage to the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature, T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance, θ<sub>JA</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is calculated using: P<sub>D</sub>(MAX)=(T<sub>J</sub>(MAX)-T<sub>A</sub>)/θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T<sub>J</sub>=150°C(typ) and disengages at T<sub>J</sub>=130°C (typ).
- The device is not guaranteed to function outside its operating conditions.
- 4) Measured on JESD51-7 4-layer board.



## **ELECTRICAL CHARACTERISTICS**

# $V_{IN} = V_{OUT}$ +0.5V, $V_{EN}$ = $V_{IN}$ , and $C_{IN}$ =1 $\mu$ F, $C_{OUT}$ =1 $\mu$ F, Typical values are at T<sub>A</sub>=25°C, unless otherwise noted.

Parameter	Symbol	Conditions	i	Min	Тур	Мах	Units	
Input Voltage Range	VIN			2		6	V	
Output Voltage Accuracy		Iout =1mA,T <sub>A</sub> =25°C		-1		1	- %	
		I <sub>OUT</sub> =100μA to 80mA,T <sub>A</sub> =25°C		C -2		2		
Oulput Voltage Accuracy		I <sub>OUT</sub> =100μA to 80mA, T <sub>A</sub> =-20°C ~85°C			±3			
Maximum Output Current	Іоит			120			mA	
Current Limit		V <sub>OUT</sub> =1.8V OUT=90% of nominal value		130	200	300	mA	
	ILIM	V <sub>OUT</sub> =2.5V OUT=90% of nominal value		160	230	330	mA	
	ILIM	V <sub>OUT</sub> =3.3V OUT=90% of nominal value		180	250	350	mA	
		V <sub>OUT</sub> =4.0V OUT=90%	of nominal value	200	270	370	mA	
			I <sub>ОUT</sub> =80mA		115	240	mV	
			I <sub>ОUT</sub> =120mA		172		mV	
		Vout =2.5V, Iout =80mA			100	220	mV	
Dropout Voltage (5)		V <sub>OUT</sub> =2.5V, I <sub>OUT</sub> =120mA V <sub>OUT</sub> =3.3V, I <sub>OUT</sub> =80mA V <sub>OUT</sub> =3.3V, I <sub>OUT</sub> =120mA			140		mV	
Diopout voltage ()					80	200	mV	
					120		mV	
		Vout =4.0V, Iout =80mA			70	180	mV	
		Vout =4.0V, Iout =120mA			110		mV	
Ground Current	lq	Ι <sub>ΟυΤ</sub> =0.05mA			50	90	μA	
Ground Current		VIN=Vout-0.1V, IOUT =0mA			50	90		
Line Regulation <sup>(6)</sup>	$V_{LNR}$	V <sub>IN</sub> =Vout+0.5V to 6V Iou⊤ =0.1mA			0.03		%/V	
Load Regulation <sup>(7)</sup>	VLDR	IOUT =1mA to 120mA			0.002		%/mA	
Shutdown Supply Current	Ishdn	V <sub>EN</sub> =0	T <sub>A</sub> =25°C		0.01	1		
			T <sub>A</sub> =85°C		0.2		μA	
Ripple Rejection	PSRR	F=1kHz, Iout =10mA			78		dB	
		F=10kHz, Iout =10mA			75			
		F=100kHz, Iout =10mA			55			
		F=100Hz to 30kHz I <sub>LOAD</sub> =10mA			16		- μV <sub>RMS</sub>	
Output Noise Voltage		F=100Hz to 30kHz ILOAD=80mA			17			
EN Startup delay <sup>(8)</sup>		$R_{LOAD}=50\Omega$				150	μs	
			T <sub>A</sub> =25°C			0.4		
V <sub>EN</sub> Logic Low Level		V <sub>IN</sub> =2V to 6	V T <sub>A</sub> =85°C			0.3	- V	
VEN Logic High Level		V <sub>IN</sub> =2V to 6V		1.5			V	



#### ELECTRICAL CHARACTERISTICS (continued)

# $V_{IN} = V_{OUT}$ +0.5V, $V_{EN}$ = $V_{IN}$ , and $C_{IN}$ =1 $\mu$ F, $C_{OUT}$ =1 $\mu$ F, Typical values are at T<sub>A</sub>=25°C, unless otherwise noted.

Parameter	Symbol	Conditions		Min	Тур	Max	Units
V Input Bigg Current		V <sub>IN</sub> =6V, V <sub>EN</sub> =6V	T <sub>A</sub> =25°C			1	μA
V <sub>EN</sub> Input Bias Current			T <sub>A</sub> =85°C		0.01		
Thermal Shutdown <sup>(9)</sup>					150		°C
Thermal Shutdown Hysteresis					20		°C

#### Notes:

5) Dropout is defined as  $V_{IN}$ - $V_{OUT}$  when  $V_{OUT}$  is 100mV below the value of  $V_{OUT}$  for  $V_{IN}$ =  $V_{OUT}$  +0.5V.

6) Line Regulation = 
$$\frac{\left|V_{OUT[V_{IN(MAX)}]} - V_{OUT[V_{IN(MIN)}]}\right|}{\left(V_{IN(MAX)} - V_{IN(MIN)}\right) \times V_{OUT(NOM)}} \times 100(\%/V)$$
7) 
$$\frac{\left|V_{OUTT}_{U_{V}}\right|}{\left(V_{OUTT}_{U_{V}}\right) - V_{OUTT}_{U_{V}}\right|}$$

Load Regulation =  $\frac{|V_{OUT}(I_{OUT(MAX)}) - V_{OUT}(I_{OUT(MMN)})|}{(I_{OUT(MAX)} - I_{OUT(MIN)}) \times V_{OUT(NOM)}} \times 100(\%/mA)$ 

8) Time needed for  $V_{OUT}$  to reach 90% of final value.

9) Guaranteed by design, not tested.



#### MP2009-ULTRA LOW NOISE, LOW DROPOUT, 120mA LINEAR REGULATOR

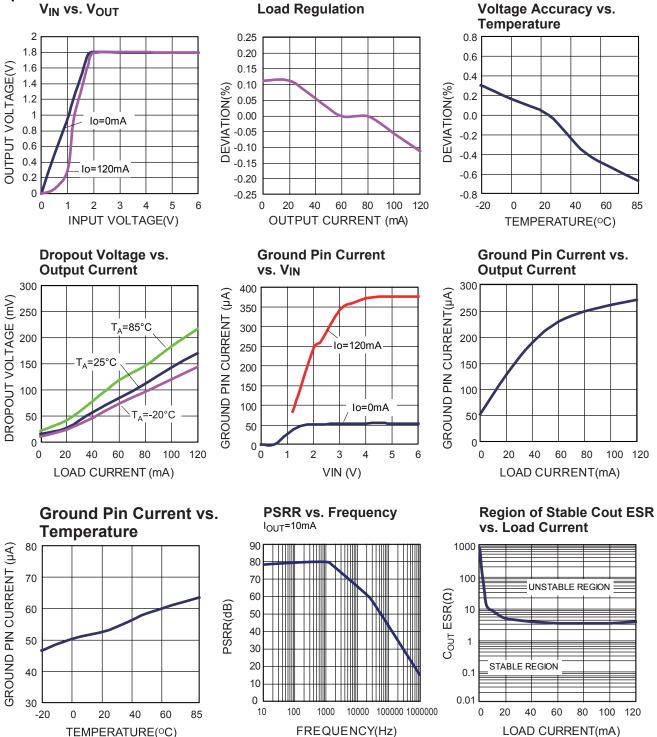
## **PIN FUNCTIONS**

Pin #	Name	Description
1	IN	Input supply
2	GND	Common Ground
3	EN	When enable pin (EN) is high, the regulator turns on; when enable pin (EN) is low, the regulator shutdown.
4	NC	No Connection
5	OUT	Output of the regulator



## **TYPICAL PERFORMANCE CHARACTERISTICS**

 $V_{IN}$ =2.3V,  $V_{OUT}$ =1.8V,  $C_{IN}$ =1 $\mu$ F,  $C_{OUT}$ =1 $\mu$ F, EN=2.3V, Typical Value at T<sub>A</sub> = 25°C unless otherwise specified.



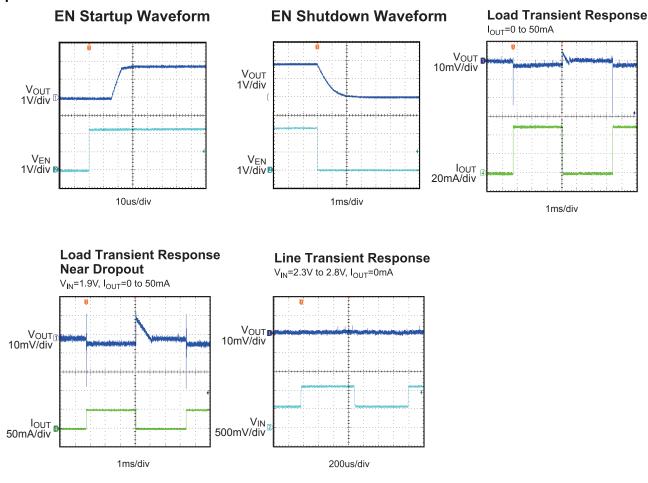
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## **TYPICAL PERFORMANCE CHARACTERISTICS** (continued)

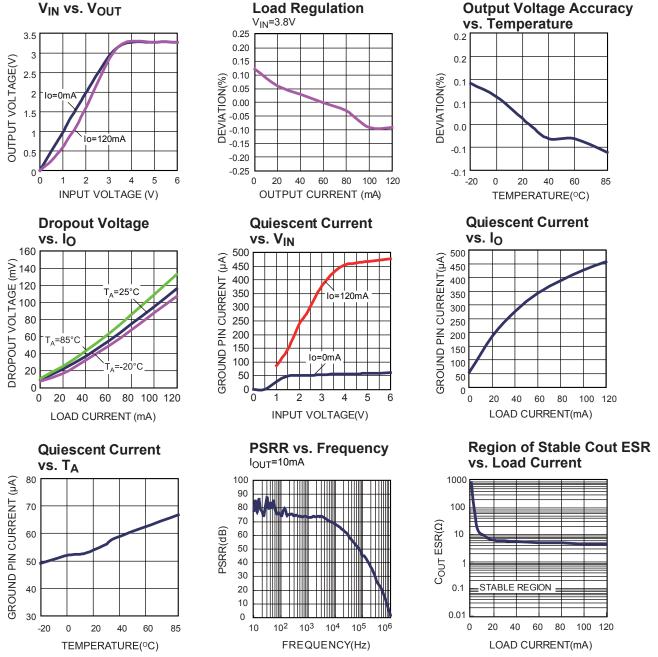
 $V_{IN}$ =2.3V,  $V_{OUT}$ =1.8V,  $C_{IN}$ =1µF,  $C_{OUT}$ =1µF, EN=2.3V, Typical Value at T<sub>A</sub> = 25°C unless otherwise specified.





### **TYPICAL PERFORMANCE CHARACTERISTICS** (continued)

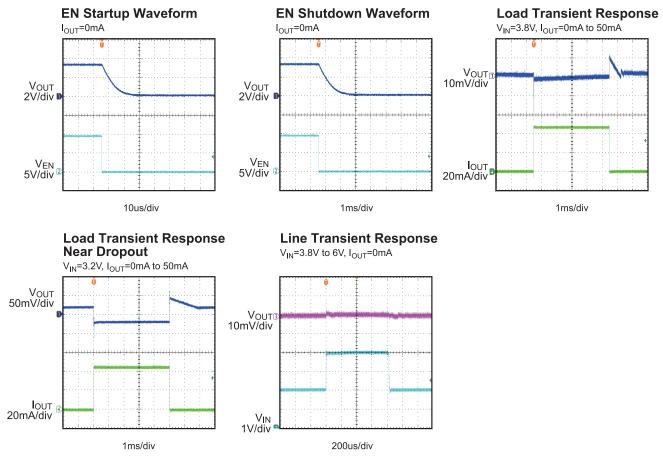
 $V_{IN}$ =3.8V,  $V_{OUT}$ =3.3V,  $C_{IN}$ =1 $\mu$ F,  $C_{OUT}$ =1 $\mu$ F, EN=3.8V, Typical Value at T<sub>A</sub> = 25°C unless otherwise specified.





## **TYPICAL PERFORMANCE CHARACTERISTICS** (continued)

 $V_{IN}$ =3.8V,  $V_{OUT}$ =3.3V,  $C_{IN}$ =1µF,  $C_{OUT}$ =1µF, EN=3.8V, Typical Value at T<sub>A</sub> = 25°C unless otherwise specified.





## FUNCTION BLOCK DIAGRAM

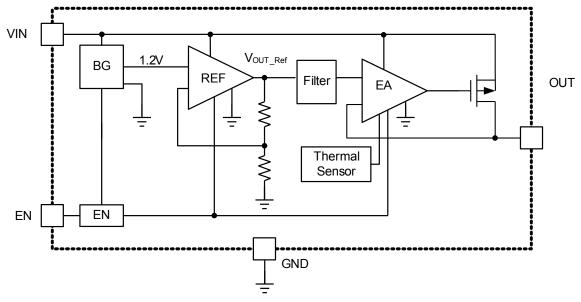


Figure1—Functional Block Diagram



## OPERATION

The MP2009 is an ultra low noise, low dropout, low-quiescent current linear regulator designed for space-restricted applications. It is intended for use in devices that requires very low voltage, low quiescent current such as wireless LAN, batterypowered equipment and hand-held equipment.

#### **Internal P-Channel Pass Transistor**

MP2009 features a  $1.4\Omega$  P-channel The MOSFET as the pass transistor. It provides several advantages over similar designs using PNP pass transistor. The P-channel MOSFET requires no base drive, which reduces guiescent current considerably and increase the battery life. PNP-based regulators waste considerable current in dropout when the pass transistor saturates. They also use high base-drive current under the large load condition. The MP2009 does not suffer from these problems and consume only 50µA of guiescent current in light load and dropout mode.

#### **Dropout Voltage**

Dropout voltage is the minimum input to output differential voltage required for the regulator to maintain an output voltage within 100mV of its nominal value. It determines the available end-oflife battery voltage in battery-powered systems. For the P-channel MOSFET pass element, the dropout voltage is a function of drain to source on resistance. Because the P-channel MOSFET pass element behaves as a low-value resistor, the dropout voltage of MP2009 is very low.

#### Shutdown

The MP2009 can be switched ON or OFF by a logic input at the EN pin. A high voltage at this pin will turn the device on. When the EN pin is low, the regulator output is off. The EN pin should be tied to VIN to keep the regulator output always on if the application does not require the shutdown feature. Do not float the EN pin.

#### **Current Limit and Thermal Protection**

The MP2009 includes an independent current limit structure which monitors and controls the Pchannel MOSFET's gate voltage to limit the guaranteed maximum output current to 120mA. Thermal protection turns off the P-channel MOSFET when the junction temperature exceeds +150°C, allowing the IC to cool. When the IC's junction temperature drops by 20°C, the PMOS will be turned on again. Thermal protection limits total power dissipation in the MP2009. For reliable operation, junction temperature should be limited to 125 °C maximum.



## **APPLICATION INFORMATION**

#### **Power Dissipation**

The power dissipation for any package depends on the thermal resistance of the case and circuit board, the temperature difference between the junction and ambient air, and the rate of airflow. The power dissipation across the device can be represented by the equation:

$$P = (V_{IN} - V_{OUT}) \times I_{OUT}$$

The allowable power dissipation can be calculated using the following equation:

$$P_{(MAX)} = (T_{Junction} - T_{Ambient}) / \theta_{JA}$$

Where  $(T_{Junction} - T_{Ambient})$  is the temperature difference between the junction and the surrounding environment,  $\theta_{JA}$  is the thermal resistance from the junction to the ambient environment. Connecting the GND pin of MP2009 to ground with a large ground plane will help the channel heat away.

#### **Output Noise and PSRR**

For the MP2009, an internal 50pF bypass capacitor with new innovative structure reduces output noises greatly. It does not need external

bypass capacitor for space-limiting applications. The power supply rejection is 75dB at 10kHz and 55dB at 100kHz. (See the PSRR vs. Frequency graph in the Typical Performance Characteristics).

#### **Input Capacitor Selection**

Use a  $1\mu$ F capacitor on the input of the MP2009. Larger values will help to improve line transient response with the drawback of increased size. Ceramic capacitors are preferred, but tantalum capacitors may also suffice.

#### **Output Capacitor Selection**

The MP2009 is designed specifically to work with very low ESR ceramic output capacitor in spacelimiting and performance consideration. Output capacitor of larger values will help to improve load transient response and reduce noise with the drawback of increased size. A 1µF ceramic capacitor with ESR lower than  $3\Omega$  is sufficient for the MP2009 application circuit. (See the Region of Stable C<sub>OUT</sub> ESR vs. Load Current graph in the Typical Performance Characteristics)



## PCB LAYOUT GUIDE

PCB layout is very important to achieve good regulation, ripple rejection, transient response and thermal performance. It is highly recommended to duplicate EVB layout for optimum performance.

If change is necessary, please follow these guidelines and take figure 2 for reference.

- Input and output bypass ceramic capacitors are suggested to be put close to the IN Pin and OUT Pin respectively.
- Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- Connect IN, OUT and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.

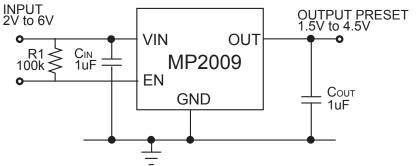


Figure 2 — MP2009 Typical Application Circuit

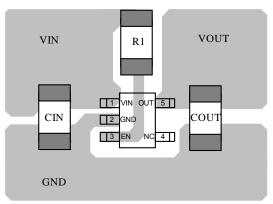


Figure 3—MP2009 Top Layer